

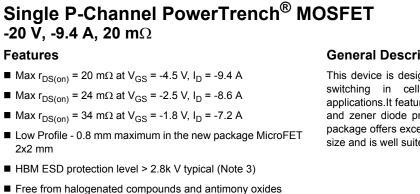
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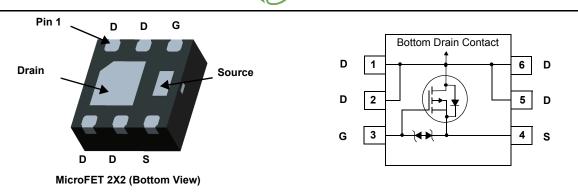
RoHS Compliant

FAIRCHILD

FDMA910PZ

General Description

This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-state resistance and zener diode protection against ESD. The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			-20	V
V _{GS}	Gate to Source Voltage			±8	V
1	-Continuous	T _A = 25°C	(Note 1a)	-9.4	^
D	-Pulsed			-45	A
D	Power Dissipation	T _A = 25°C	(Note 1a)	2.4	W
P _D	Power Dissipation	T _A = 25°C	(Note 1b)	0.9	vv
T _J , T _{STG}	Operating and Storage Junction Tempe	erature Range		-55 to +150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	145	C/W

Package Marking and Ordering Information

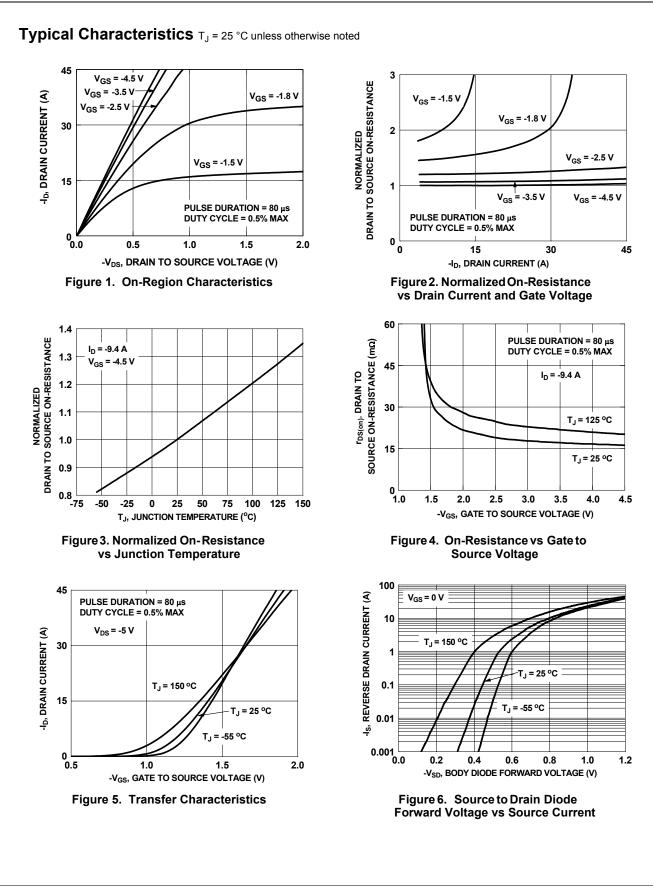
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
910	FDMA910PZ	MicroFET 2X2	7"	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-20			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, referenced to 25 °C		-12		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 V, V_{DS} = 0 V$			±1	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-0.4	-0.5	-1.5	V
$\Delta V_{GS(th)}$ $\Delta T_{.1}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C	-	3		mV/°C
0		V _{GS} = -4.5 V, I _D = -9.4 A		16	20	
		V _{GS} = -2.5 V, I _D = -8.6 A		19	24	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = -1.8 V, I _D = -7.2 A		24	34	
		V _{GS} = -4.5 V, I _D = -9.4 A, T _J = 125 °C		20	25	
Dynamic C _{iss}	Forward Transconductance Characteristics Input Capacitance	V _{DD} = -5 V, I _D = -9.4 A		52 2110	2805	S pF
Dynamic C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance			2110 414	620	pF pF
C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DD} = -5 V, I_D = -9.4 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$		2110		pF
Dynamic C _{iss} C _{oss} C _{rss} Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics	$V_{DD} = -5 V, I_D = -9.4 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$		2110 414 388	620 580	pF pF pF
Dynamic C _{iss} C _{oss} C _{rss} Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time	$V_{DD} = -5 V, I_D = -9.4 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$		2110 414 388 9.4	620 580 19	pF pF pF ns
Dynamic C _{iss} C _{oss} C _{rss} Switching t _{d(on)}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		2110 414 388 9.4 19	620 580 19 34	pF pF pF ns ns
Dynamic C _{iss} C _{oss} C _{rss} Switching t _{d(on)} t _r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time	$V_{DD} = -5 V, I_D = -9.4 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$ f = 1 MHz $V_{DD} = -10 V, I_D = -9.4 A,$		2110 414 388 9.4 19 135	620 580 19 34 216	pF pF pF ns ns
Dynamic C _{iss} C _{oss} Crss Switching t _d (on) t _r t _d (off) t _f	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = -10 \text{ V}, \text{ I}_{D} = -9.4 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		2110 414 388 9.4 19	620 580 19 34	pF pF pF ns ns
Dynamic C _{iss} C _{oss} C _{rss} Switching t _d (on) t _r t _{d(off)} t _f Q _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DD} = -5 V, I_D = -9.4 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$ f = 1 MHz $V_{DD} = -10 V, I_D = -9.4 A,$		2110 414 388 9.4 19 135 103	620 580 19 34 216 165	pF pF pF ns ns ns ns
Dynamic C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = -10 \text{ V}, \text{ I}_{D} = -9.4 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = -4.5 \text{ V}, \text{ V}_{DD} = -10 \text{ V},$		2110 414 388 9.4 19 135 103 21	620 580 19 34 216 165	pF pF pF ns ns ns ns ns
$\begin{array}{c} \hline \textbf{Dynamic} \\ \hline \textbf{C}_{iss} \\ \hline \textbf{C}_{oss} \\ \hline \textbf{C}_{rss} \\ \hline \textbf{Switching} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_{f} \\ \hline \textbf{Q}_{g} \\ \hline \textbf{Q}_{gs} \\ \hline \textbf{Q}_{gd} \\ \hline \textbf{Q}_{gd} \\ \hline \end{array}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = -10 \text{ V}, \text{ I}_{D} = -9.4 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = -4.5 \text{ V}, \text{ V}_{DD} = -10 \text{ V},$		2110 414 388 9.4 19 135 103 21 2.5	620 580 19 34 216 165	pF pF pF ns ns ns nC nC
Dynamic C _{iss} C _{oss} C _{rss} Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gd} Drain-Sou	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = -10 \text{ V}, \text{ I}_{D} = -9.4 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = -4.5 \text{ V}, \text{ V}_{DD} = -10 \text{ V},$ $I_{D} = -9.4 \text{ A}$		2110 414 388 9.4 19 135 103 21 2.5	620 580 19 34 216 165	pF pF pF ns ns ns nC nC
Dynamic C _{iss} C _{oss} C _{rss} Switching td(on) tr td(off) tf Qg Qgs Qgd	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = -10 \text{ V}, \text{ I}_{D} = -9.4 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = -4.5 \text{ V}, \text{ V}_{DD} = -10 \text{ V},$ $I_{D} = -9.4 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -2 \text{ A} \text{ (Note 2)}$		2110 414 388 9.4 19 135 103 21 2.5 6	620 580 19 34 216 165 29	pF pF pF ns ns ns nC nC nC
Dynamic C _{iss} C _{oss} C _{rss} Switching td(on) tr td(off) tf Qg Qg Qgd Drain-Sou	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -9.4 \text{ A}$ $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = -10 \text{ V}, \text{ I}_{D} = -9.4 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = -4.5 \text{ V}, \text{ V}_{DD} = -10 \text{ V},$ $I_{D} = -9.4 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -2 \text{ A} \text{ (Note 2)}$		2110 414 388 9.4 19 135 103 21 2.5 6 -0.6	620 580 19 34 216 165 29 -1.2	pF pF pF ns ns ns nC nC V

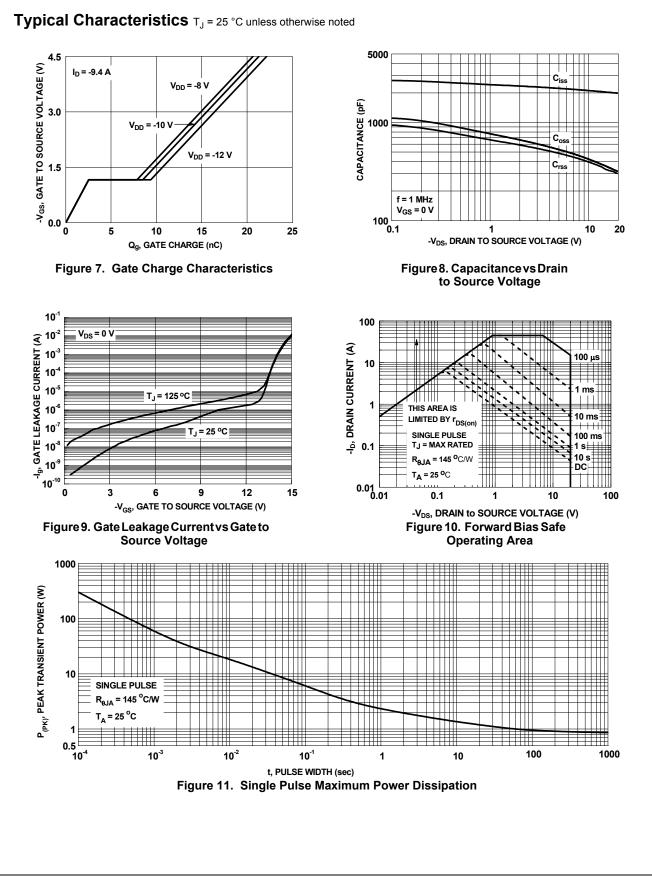
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
 The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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FDMA910PZ Single P-Channel PowerTrench[®] MOSFET

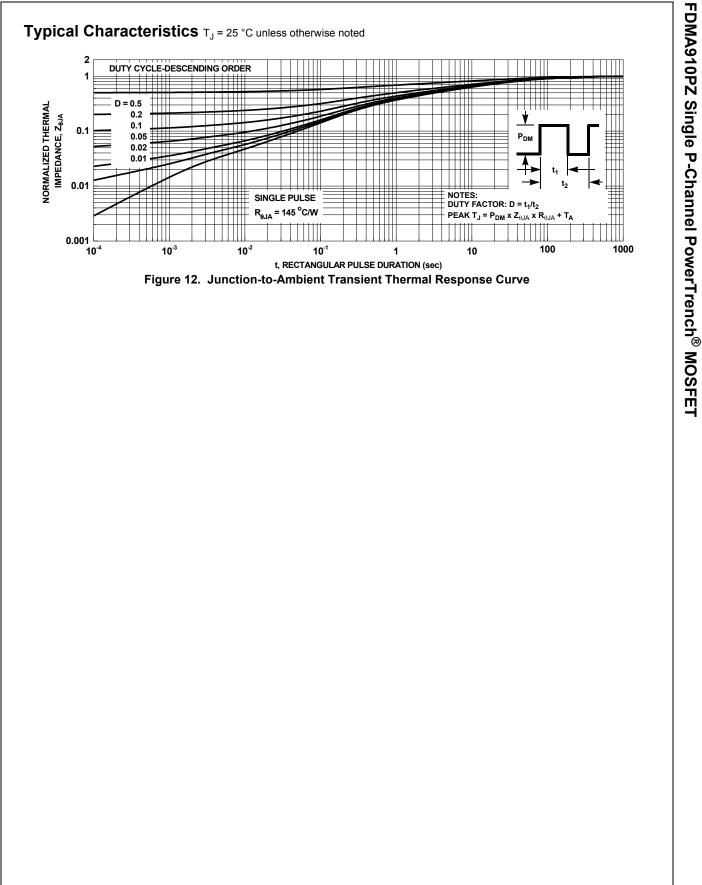


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FDMA910PZ Single P-Channel PowerTrench[®] MOSFET





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2.30

0.40(6X)

4

3

0.45

(0.20)

0.66

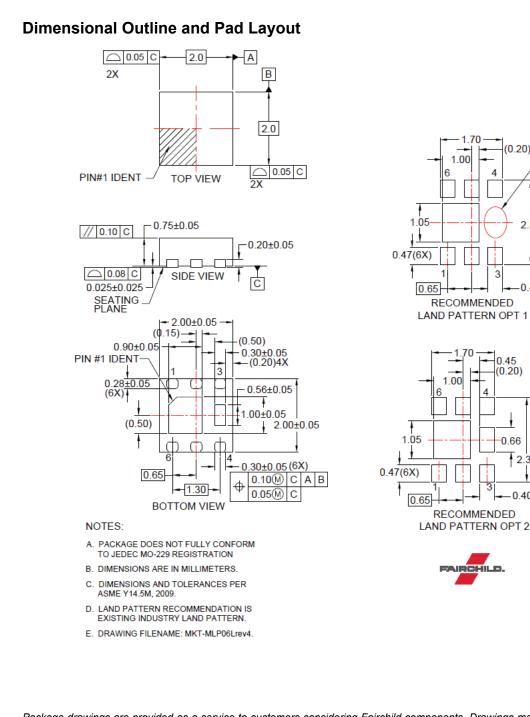
2.30

0.40(7X)

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110		Sync-Lock™	仙童 ™
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